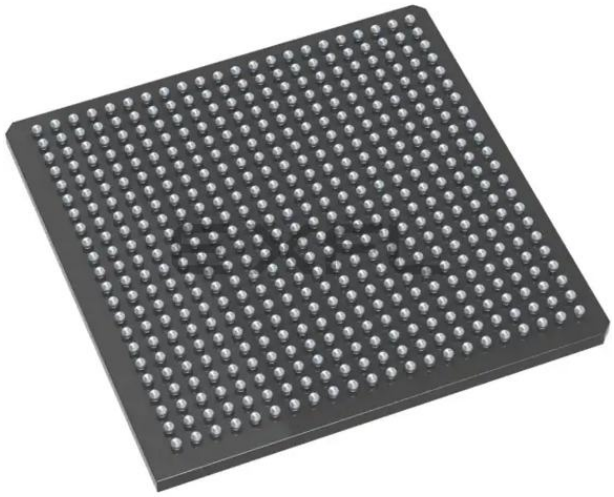

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	8064
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	317
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	484-BGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax500-1fg484

Calculating Power Dissipation

Table 2-3 • **Standby Current**

Device	Temperature	ICCA	ICCDA	ICCBANK		ICCPLL	ICCCP[1]		IIH, IIL, IOZ[2]	Units
		Standby Current (Core)	Standby Current, Differential I/O	Standby Current per I/O Bank		Standby Current per PLL	Standby Current, Charge Pump			
				2.5 V VCCI	3.3 V VCCI		Active	Bypassed Mode		
AX125	Typical at 25°C	1.5	1.5	0.2	0.3	0.2	0.3	0.01	±0.01	mA
	70°C	15	6	0.5	0.75	1	0.4	0.01	±0.01	mA
	85°C	25	6	0.6	0.8	1	0.4	0.2	±0.01	mA
	125°C	50	8	1	1.5	2	0.4	0.5	±0.01	mA
AX250	Typical at 25°C	1.5	1.4	0.25	0.4	0.2	0.3	0.01	±0.01	mA
	70°C	30	7	0.8	0.9	1	0.4	0.01	±0.01	mA
	85°C	40	7	0.8	1	1	0.4	0.2	±0.01	mA
	125°C	70	9	1.3	1.8	2	0.4	0.5	±0.01	mA
AX500	Typical at 25°C	5	1.4	0.4	0.75	0.2	0.3	0.01	±0.01	mA
	70°C	60	7	1	1.5	1	0.4	0.01	±0.01	mA
	85°C	80	7	1	1.9	1	0.4	0.2	±0.01	mA
	125°C	180	9	1.75	2.5	1.5	0.4	0.5	±0.01	mA
AX1000	Typical at 25°C	7.5	1.5	0.5	1.25	0.2	0.3	0.01	±0.01	mA
	70°C	80	8	1.5	3	1	0.4	0.01	±0.01	mA
	85°C	120	8	1.5	3.4	1	0.4	0.2	±0.01	mA
	125°C	200	10	3	4	1.5	0.4	0.5	±0.01	mA
AX2000	Typical at 25°C	20	1.6	0.7	1.5	0.2	0.3	0.01	±0.01	mA
	70°C	160	10	2	7	1	0.4	0.01	±0.01	mA
	85°C	200	10	3	8	1	0.4	0.2	±0.01	mA
	125°C	500	15	4	10	1.5	0.4	0.5	±0.01	mA

Notes:

1. *ICCCP Active is the ICCDA or the Internal Charge Pump current. ICCCP Bypassed mode is the External Charge Pump current IIH (VPUMP pin).*
2. *IIH, IIL, or IOZ values are measured with inputs at the same level as VCCI for IIH and GND for IIL and IOZ.*

Table 2-5 • **Different Components Contributing to the Total Power Consumption in Axcelerator Devices**

Component	Definition	Device Specific Value (in µW/MHz)				
		AX125	AX250	AX500	AX1000	AX2000
P1	Core tile HCLK power component	33	49	71	130	216
P2	R-cell power component	0.2	0.2	0.2	0.2	0.2
P3	HCLK signal power dissipation	4.5	4.5	9	13.5	18
P4	Core tile RCLK power component	33	49	71	130	216
P5	R-cell power component	0.3	0.3	0.3	0.3	0.3
P6	RCLK signal power dissipation	6.5	6.5	13	19.5	26
P7	Power dissipation due to the switching activity on the R-cell	1.6	1.6	1.6	1.6	1.6
P8	Power dissipation due to the switching activity on the C-cell	1.4	1.4	1.4	1.4	1.4
P9	Power component associated with the input voltage	10	10	10	10	10
P10	Power component associated with the output voltage	See table Per pin contribution				
P11	Power component associated with the read operation in the RAM block	25	25	25	25	25
P12	Power component associated with the write operation in the RAM block	30	30	30	30	30
P13	Core PLL power component	1.5	1.5	1.5	1.5	1.5

Ptotal = Pdc + Pac

P_{dc} = ICCA * VCCA

P_{ac} = $P_{HCLK} + P_{CLK} + P_{R\text{-}cells} + P_{C\text{-}cells} + P_{inputs} + P_{outputs} + P_{memory} + P_{PLL}$

P_{HCLK} = (P1 + P2 * s + P3 * sqrt[s]) * Fs

s = the number of R-cells clocked by this clock

Fs = the clock frequency

PCLK = (P4 + P5 * s + P6 * sqrt[s]) * Fs

s = the number of R-cells clocked by this clock

Fs = the clock frequency

PR-cells = P7 * ms * Fs

ms = the number of R-cells switching at each Fs cycle

Fs = the clock frequency

PC-cells = P8 * mc * Fs

mc = the number of C-cells switching at each Fs cycle

Fs = the clock frequency

Pinputs = P9 * pi * Fpi

pi = the number of inputs

F_{pi} = the average input frequency

I/O Banks and Compatibility

Since each I/O bank has its own user-assigned input reference voltage (VREF) and an input/output supply voltage (VCCI), only I/Os with compatible standards can be assigned to the same bank.

Table 2-11 shows the compatible I/O standards for a common VREF (for voltage-referenced standards). Similarly, Table 2-12 shows compatible standards for a common VCCI.

Table 2-11 • **Compatible I/O Standards for Different VREF Values**

VREF	Compatible Standards
1.5 V	SSTL 3 (Class I and II)
1.25 V	SSTL 2 (Class I and II)
1.0 V	GTL+ (2.5V and 3.3V Outputs)
0.75 V	HSTL (Class I)

Table 2-12 • **Compatible I/O Standards for Different VCCI Values**

VCCI[1]	Compatible Standards	VREF
3.3 V	LVTTL, PCI, PCI-X, LVPECL, GTL+ 3.3 V	1.0
3.3 V	SSTL 3 (Class I and II), LVTTL, PCI, LVPECL	1.5
2.5 V	LVCMOS 2.5 V, GTL+ 2.5 V, LVDS[2]	1.0
2.5 V	LVCMOS 2.5 V, SSTL 2 (Classes I and II), LVDS[2]	1.25
1.8 V	LVCMOS 1.8 V	N/A
1.5 V	LVCMOS 1.5 V, HSTL Class I	0.75

Notes:

1. *VCCI is used for both inputs and outputs*
2. *VCCI tolerance is* ±5%

User I/O Naming Conventions

Due to the complex and flexible nature of the Axcelerator family's user I/Os, a naming scheme is used to show the details of the I/O. The naming scheme explains to which bank an I/O belongs, as well as the pairing and pin polarity for differential I/Os (Figure 2-7).

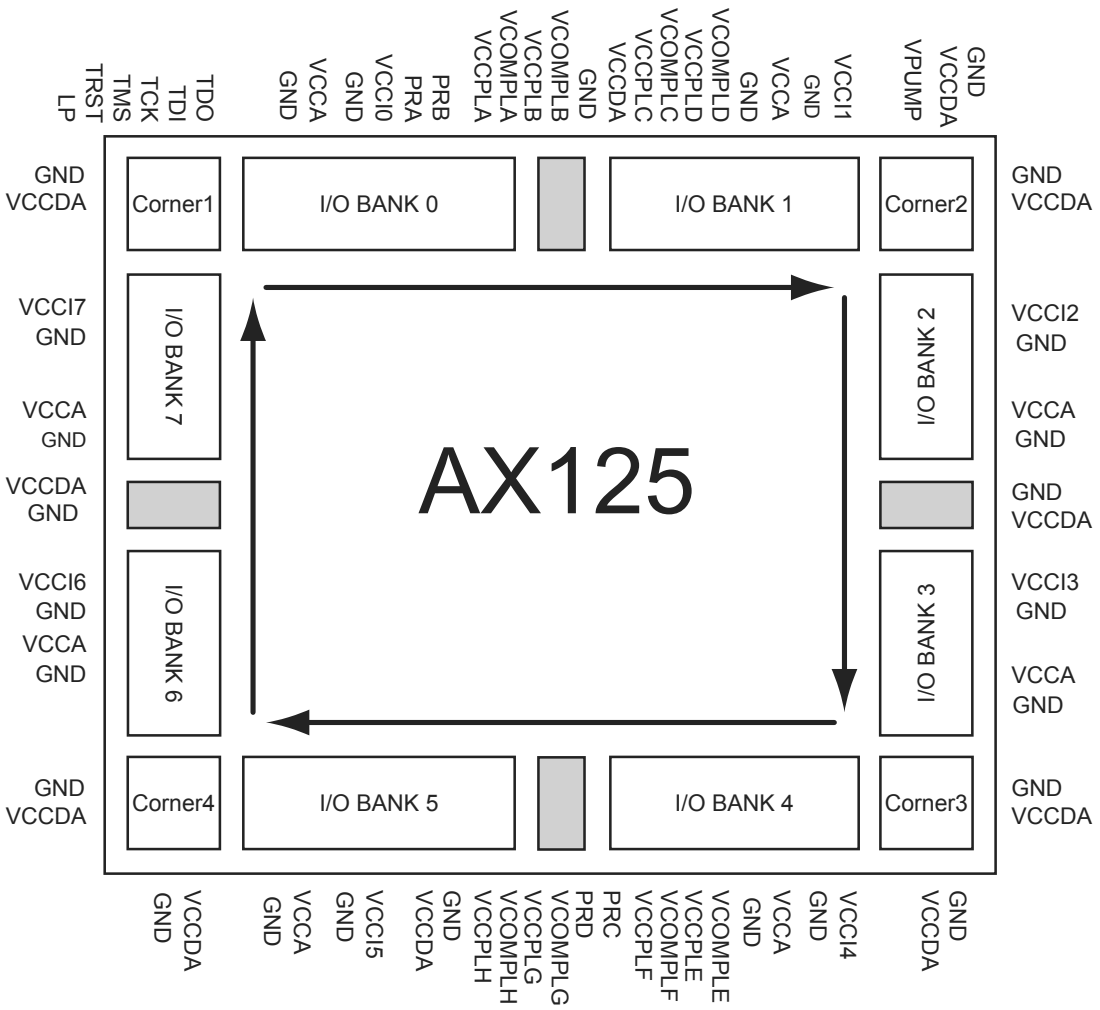
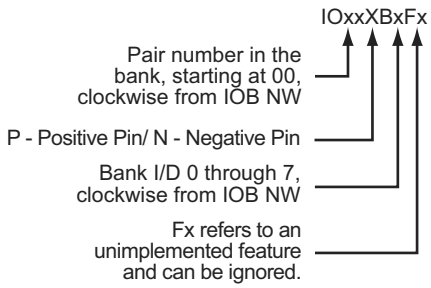


Figure 2-7 • **I/O Bank and Dedicated Pin Layout**



Examples:

IO12PB1F1 is the positive pin of the thirteenth pair of the first I/O bank (IOB NE). IO12PB1 combined with IO12NB1 form a differential pair.

For those I/Os that can be employed either as a user I/O or as a special function, the following nomenclature is used:

IOxxXBxFx/special_function_name

IOxxPB1Fx/xCLKx this pin can be configured as a clock input or as a user I/O.

Figure 2-8 • **General Naming Schemes**

***Table 2-22* • 3.3 V LVTTL I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVTTL Output Drive Strength = 1 (8 mA) / High Slew Rate								
t_{DP}	Input Buffer		1.68		1.92		2.26	ns
t_{PY}	Output Buffer		4.23		4.81		5.66	ns
t_{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		4.64		5.28		6.21	ns
t_{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		4.23		4.81		5.66	ns
t_{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.89		1.91		1.91	ns
t_{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.01		2.02		2.03	ns
t_{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t_{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

2.5 V LVCMOS

Low-Voltage Complementary Metal-Oxide Semiconductor for 2.5 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 2.5 V applications. It uses a 3.3 V tolerant CMOS input buffer and a push-pull output buffer.

***Table 2-23* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
-0.3	0.7	1.7	3.6	0.4	2.0	12	–12

AC Loadings

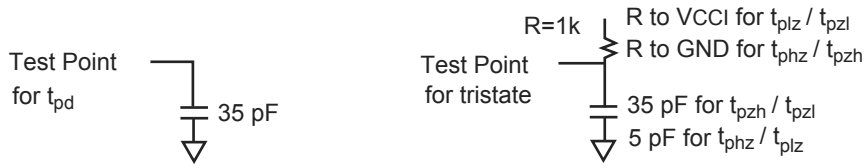


***Figure 2-16* • AC Test Loads**

***Table 2-24* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
0	2.5	1.25	N/A	35

*Note: * Measuring Point = VTRIP*

HSTL Class I

High-Speed Transceiver Logic is a general-purpose high-speed 1.5 V bus standard (EIA/JESD8-6). The Axcelerator devices support Class I. This requires a differential amplifier input buffer and a push-pull output buffer.

***Table 2-41* • DC Input and Output Levels**

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	**Max., V**	**Min., V**	**Max., V**	**Max., V**	**Min., V**	**mA**	**mA**
-0.3	VREF – 0.1	VREF + 0.1	3.6	0.4	VCC – 0.4	8	-8

AC Loadings

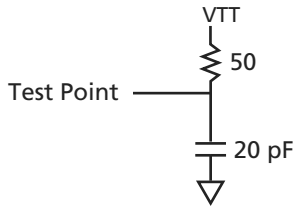


***Figure 2-20 •* AC Test Loads**

***Table 2-42* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C_{load} (pF)
VREF –0.5	VREF + 0.5	VREF	0.75	20

*Note: * Measuring Point = VTRIP*

Timing Characteristics

***Table 2-43* • 1.5 V HSTL Class I I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 1.425 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
1.5 V HSTL Class I I/O Module Timing								
t_{DP}	Input Buffer		1.80		2.05		2.41	ns
t_{PY}	Output Buffer		4.90		5.58		6.56	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Glitch Elimination

An analog filter is added to each FIFO controller to guarantee glitch-free FIFO-flag logic.

Overflow and Underflow Control

The counter MSB keeps track of the difference between the read address (RA) and the write address (WA). The EMPTY flag is set when the read and write addresses are equal. To prevent underflow, the write address is double-sampled by the read clock prior to comparison with the read address (part A in Figure 2-64). To prevent overflow, the read address is double-sampled by the write clock prior to comparison to the write address (part B in Figure 2-64).

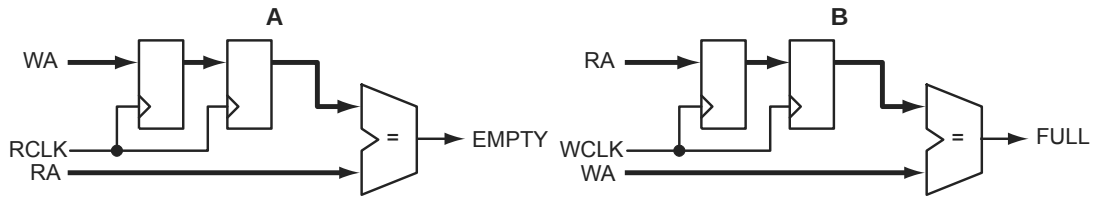


Figure 2-64 • **Overflow and Underflow Control**

FIFO Configurations

Unlike the RAM, the FIFO's write width and read width cannot be specified independently. For the FIFO, the write and read widths must be the same. The WIDTH pins are used to specify one of six allowable word widths, as shown in Table 2-96.

Table 2-96 • **FIFO Width Configurations**

WIDTH(2:0)	W x D
000	1 x 4k
001	2 x 2k
010	4 x 1k
011	9 x 512
100	18 x 256
101	36 x 128
11x	reserved

The DEPTH pins allow RAM cells to be cascaded to create larger FIFOs. The four pins allow depths of 2, 4, 8, and 16 to be specified. Table 2-86 on page 2-87 describes the FIFO depth options for various data width and memory blocks.

Interface

Figure 2-65 on page 2-99 shows a logic block diagram of the Axcelerator FIFO module.

Cascading FIFO Blocks

FIFO blocks can be cascaded to create deeper FIFO functions. When building larger FIFO blocks, if the word width can be fractured in a multi-bit FIFO, the fractured word configuration is recommended over a cascaded configuration. For example, 256x36 can be configured as two blocks of 256x18. This should be taken into account when building the FIFO blocks manually. However, when using SmartGen, the user only needs to specify the depth and width of the necessary FIFO blocks. SmartGen automatically configures these blocks to optimize performance.

throughout the fabric of the device and may be programmed by the user to thwart attempts to reverse engineer the device by attempting to exploit either the programming or probing interfaces. Both invasive and noninvasive attacks against an Axcelerator device that access or bypass these security fuses will destroy access to the rest of the device. (refer to the *Design Security in Nonvolatile Flash and Antifuse FPGAs* white paper).

Look for this symbol to ensure your valuable IP is protected with highest level of security in the industry.

Figure 2-69 • **FuseLock Logo**

To ensure maximum security in Axcelerator devices, it is recommended that the user program the device security fuse (SFUS). When programmed, the Silicon Explorer II testing probes are disabled to prevent internal probing, and the programming interface is also disabled. All JTAG public instructions are still accessible by the user.

For more information, refer to the *Implementation of Security in Actel Antifuse FPGAs* application note.

Global Set Fuse

The Global Set Fuse determines if all R-cells and I/O registers (InReg, OutReg, and EnReg) are either cleared or preset by driving the GCLR and GPSET inputs of all R-cells and I/O Registers (Figure 2-31 on page 2-58). Default setting is to clear all registers (GCLR = 0 and GPSET =1) at device power-up. When the GBSETFUS option is checked during FUSE file generation, all registers are preset (GCLR = 1 and GPSET= 0). A local CLR or PRESET will take precedence over this setting. Both pins are pulled High during normal device operation. For use details, see the Libero IDE online help.

Silicon Explorer II Probe Interface

Silicon Explorer II is an integrated hardware and software solution that, in conjunction with the Designer tools, allows users to examine any of the internal nets (except I/O registers) of the device while it is operating in a prototype or a production system. The user can probe up to four nodes at a time without changing the placement and routing of the design and without using any additional device resources. Highlighted nets in Designer's ChipPlanner can be accessed using Silicon Explorer II in order to observe their real time values.

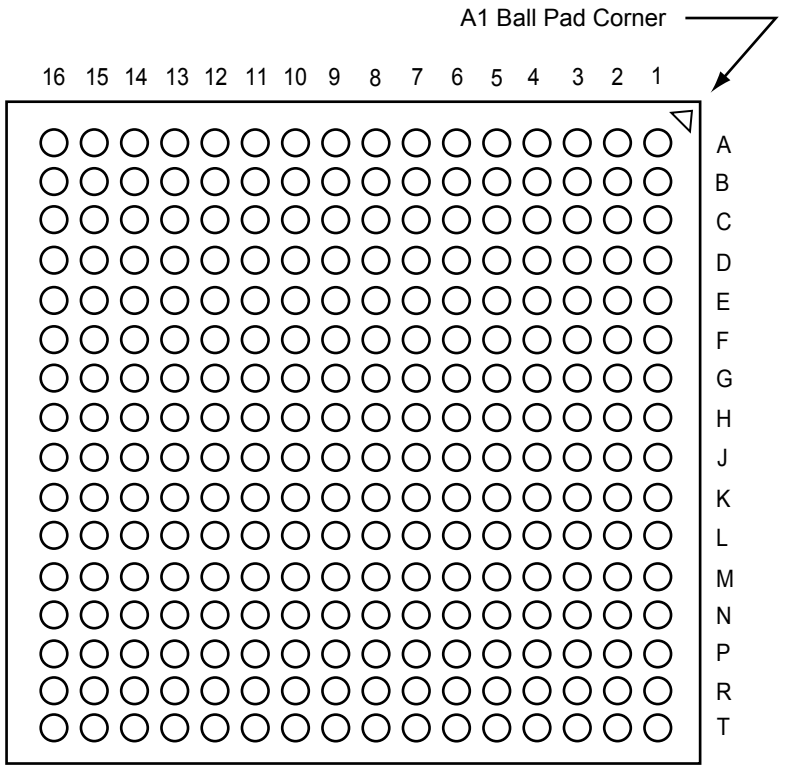
Silicon Explorer II's noninvasive method does not alter timing or loading effects, thus shortening the debug cycle. In addition, Silicon Explorer II does not require relayout or additional MUXes to bring signals out to external pins, which is necessary when using programmable logic devices from other suppliers. By eliminating multiple place-and-route program cycles, the integrity of the design is maintained throughout the debug process.

Each member of the Axcelerator family has four external pads: PRA, PRB, PRC, and PRD. These can be used to bring out four probe signals from the Axcelerator device (note that the AX125 only has two probe signals that can be observed: PRA and PRB). Each core tile has up to two probe signals. To disallow probing, the SFUS security fuse in the silicon signature has to be programmed (see "Special Fuses" on page 2-108).

Silicon Explorer II connects to the host PC using a standard serial port connector. Connections to the circuit board are achieved using a nine-pin D-Sub connector (Figure 1-9 on page 1-7). Once the design has been placed-and-routed, and the Axcelerator device has been programmed, Silicon Explorer II can be connected and the Explorer software can be launched.

Silicon Explorer II comes with an additional optional PC hosted tool that emulates an 18-channel logic analyzer. Four channels are used to monitor four internal nodes, and 14 channels are available to probe external signals. The software included with the tool provides the user with an intuitive interface that allows for easy viewing and editing of signal waveforms.

FG256



Note

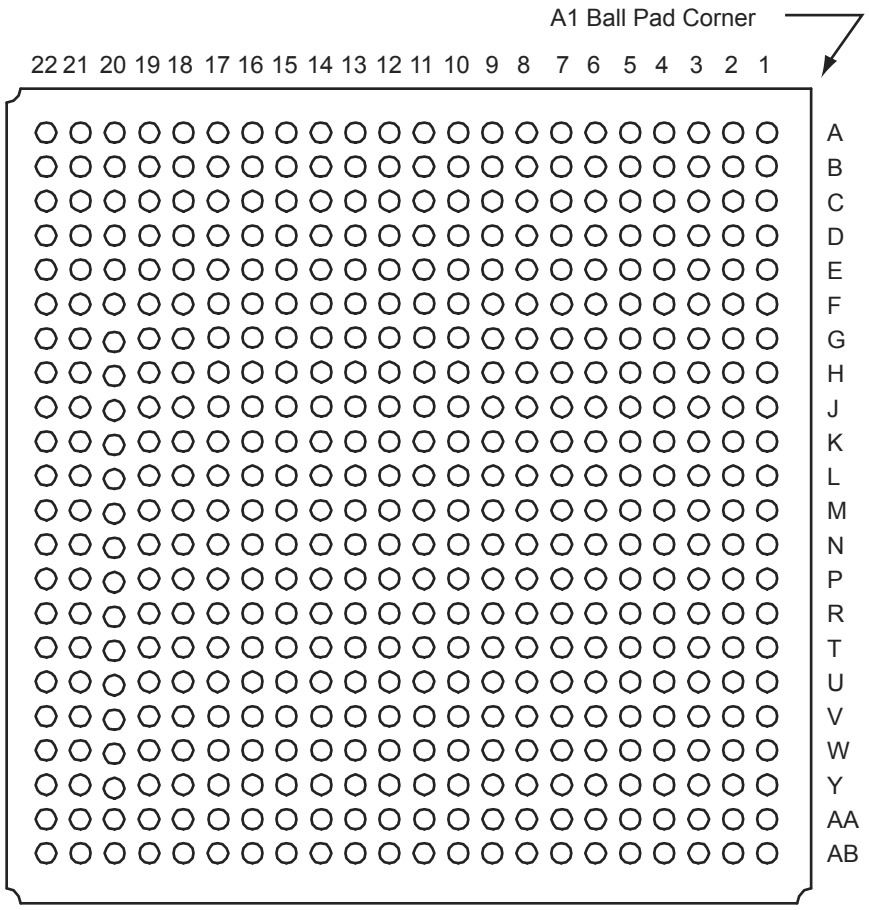
For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

FG256	
AX250 Function	Pin Number
Bank 0	
IO01NB0F0	B4
IO01PB0F0	B3
IO03NB0F0	A4
IO03PB0F0	A3
IO05NB0F0	B6
IO05PB0F0	B5
IO07NB0F0	A6
IO07PB0F0	A5
IO12NB0F0/HCLKAN	B8
IO12PB0F0/HCLKAP	B7
IO13NB0F0/HCLKBN	A9
IO13PB0F0/HCLKBP	A8
Bank 1	
IO14NB1F1/HCLKCN	C10
IO14PB1F1/HCLKCP	C9
IO15NB1F1/HCLKDN	B11
IO15PB1F1/HCLKDP	B10
IO17NB1F1	A13
IO17PB1F1	A12
IO19NB1F1	B13
IO19PB1F1	B12
IO21NB1F1	C12
IO21PB1F1	C11
IO23NB1F1	A15
IO23PB1F1	B14
IO26NB1F1	C15
IO26PB1F1	C14
IO27NB1F1	D13
IO27PB1F1	D12
Bank 2	
IO29NB2F2	F13
IO29PB2F2	E13
IO30NB2F2	F14
IO30PB2F2	E14

FG256	
AX250 Function	Pin Number
IO32NB2F2	C16
IO32PB2F2	B16
IO33NB2F2	F15
IO33PB2F2	E15
IO35NB2F2	H13
IO35PB2F2	G13
IO36NB2F2	E16
IO36PB2F2	D16
IO38NB2F2	H15
IO38PB2F2	G15
IO39NB2F2	H14
IO39PB2F2	G14
IO40NB2F2	G16
IO40PB2F2	F16
IO43NB2F2	K15
IO43PB2F2	K16
IO44NB2F2	J16
IO44PB2F2	H16
Bank 3	
IO45NB3F3	K13
IO45PB3F3	J13
IO46NB3F3	K14
IO46PB3F3	J14
IO52NB3F3	L15
IO52PB3F3	L16
IO54NB3F3	P16
IO54PB3F3	N16
IO55PB3F3	M16
IO56NB3F3	P15
IO56PB3F3	R16
IO58NB3F3	N15
IO58PB3F3	M15
IO59NB3F3	M13
IO59PB3F3	L13
IO61NB3F3	M14

FG256	
AX250 Function	Pin Number
IO61PB3F3	L14
Bank 4	
IO62NB4F4	N12
IO62PB4F4	N13
IO63NB4F4	T14
IO63PB4F4	R14
IO66PB4F4	T15
IO67NB4F4	R12
IO67PB4F4	R13
IO69NB4F4	P11
IO69PB4F4	P12
IO70PB4F4	T11
IO73NB4F4	T12
IO73PB4F4	T13
IO74NB4F4/CLKEN	R9
IO74PB4F4/CLKEP	R10
IO75NB4F4/CLKFN	T8
IO75PB4F4/CLKFP	T9
Bank 5	
IO76NB5F5/CLKGN	P7
IO76PB5F5/CLKGP	P8
IO77NB5F5/CLKHN	R6
IO77PB5F5/CLKHP	R7
IO79NB5F5	T5
IO79PB5F5	T6
IO81NB5F5	P5
IO81PB5F5	P6
IO83NB5F5	T3
IO83PB5F5	T4
IO85NB5F5	R3
IO85PB5F5	R4
IO88NB5F5	R1
IO88PB5F5	T2
IO89NB5F5	N4
IO89PB5F5	N5

FG484



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

FG896	
AX1000 Function	Pin Number
GND	A13
GND	A18
GND	A2
GND	A23
GND	A29
GND	A8
GND	AA10
GND	AA21
GND	AA28
GND	AA3
GND	AB2
GND	AB22
GND	AB29
GND	AB9
GND	AC1
GND	AC30
GND	AE25
GND	AE6
GND	AF26
GND	AF5
GND	AG27
GND	AG4
GND	AH10
GND	AH15
GND	AH16
GND	AH21
GND	AH28
GND	AH3
GND	AJ1
GND	AJ2
GND	AJ22
GND	AJ29
GND	AJ30
GND	AJ9
GND	AK13

FG896	
AX1000 Function	Pin Number
GND	AK18
GND	AK2
GND	AK23
GND	AK29
GND	AK8
GND	B1
GND	B2
GND	B22
GND	B29
GND	B30
GND	B9
GND	C10
GND	C15
GND	C16
GND	C21
GND	C28
GND	C3
GND	D27
GND	D28
GND	D4
GND	E26
GND	E5
GND	H1
GND	H30
GND	J2
GND	J22
GND	J29
GND	J9
GND	K10
GND	K21
GND	K28
GND	K3
GND	L11
GND	L20
GND	M12

FG896	
AX1000 Function	Pin Number
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	M18
GND	M19
GND	N1
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N18
GND	N19
GND	N30
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P18
GND	P19
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	R18
GND	R19
GND	R28
GND	R3

FG896	
AX2000 Function	Pin Number
VCCIB3	AH30
VCCIB3	T21
VCCIB3	U21
VCCIB3	V21
VCCIB3	W21
VCCIB3	W22
VCCIB3	Y21
VCCIB3	Y22
VCCIB4	AA16
VCCIB4	AA17
VCCIB4	AA18
VCCIB4	AA19
VCCIB4	AA20
VCCIB4	AB19
VCCIB4	AB20
VCCIB4	AB21
VCCIB4	AJ28
VCCIB4	AK28
VCCIB5	AA11
VCCIB5	AA12
VCCIB5	AA13
VCCIB5	AA14
VCCIB5	AA15
VCCIB5	AB10
VCCIB5	AB11
VCCIB5	AB12
VCCIB5	AJ3
VCCIB5	AK3
VCCIB6	AA9
VCCIB6	AH1
VCCIB6	AH2
VCCIB6	T10
VCCIB6	U10
VCCIB6	V10
VCCIB6	W10

FG896	
AX2000 Function	Pin Number
VCCIB6	W9
VCCIB6	Y10
VCCIB6	Y9
VCCIB7	C1
VCCIB7	C2
VCCIB7	K9
VCCIB7	L10
VCCIB7	L9
VCCIB7	M10
VCCIB7	M9
VCCIB7	N10
VCCIB7	P10
VCCIB7	R10
VCCPLA	G14
VCCPLB	H15
VCCPLC	G17
VCCPLD	J16
VCCPLE	AH17
VCCPLF	AC16
VCCPLG	AH14
VCCPLH	AD15
VCOMPLA	F14
VCOMPLB	J15
VCOMPLC	F17
VCOMPLD	H16
VCOMPLE	AF17
VCOMPLF	AD16
VCOMPLG	AF14
VCOMPLH	AB15
VPUMP	G24

FG1152	
AX2000 Function	**Pin Number**
IO207PB4F19	AL20
IO208NB4F19	AG19
IO208PB4F19	AF19
IO209NB4F19	AN18
IO209PB4F19	AP18
IO210NB4F19	AE19
IO210PB4F19	AD19
IO211NB4F19	AL18
IO211PB4F19	AM18
IO212NB4F19/CLKEN	AJ20
IO212PB4F19/CLKEP	AK20
IO213NB4F19/CLKFN	AJ18
IO213PB4F19/CLKFP	AJ19
Bank 5	
IO214NB5F20/CLKGN	AJ16
IO214PB5F20/CLKGP	AJ17
IO215NB5F20/CLKHN	AJ15
IO215PB5F20/CLKHP	AK15
IO216NB5F20	AD16
IO216PB5F20	AE17
IO217NB5F20	AM17
IO217PB5F20	AL17
IO218NB5F20	AG16
IO218PB5F20	AF16
IO219NB5F20	AM16
IO219PB5F20	AL16
IO220NB5F20	AP16
IO220PB5F20	AN16
IO221NB5F20	AN15
IO221PB5F20	AP15
IO222NB5F20	AD15
IO222PB5F20	AE16
IO223NB5F21	AL14
IO223PB5F21	AL15
IO224NB5F21	AN14

FG1152	
AX2000 Function	**Pin Number**
IO224PB5F21	AP14
IO225NB5F21	AK13
IO225PB5F21	AK14
IO226NB5F21	AE15
IO226PB5F21	AF15
IO227NB5F21	AG14
IO227PB5F21	AG15
IO228NB5F21	AJ13
IO228PB5F21	AJ14
IO229NB5F21	AM13
IO229PB5F21	AM14
IO230NB5F21	AE14
IO230PB5F21	AF14
IO231NB5F21	AN12
IO231PB5F21	AP12
IO232NB5F21	AG13
IO232PB5F21	AH13
IO233NB5F21	AL12
IO233PB5F21	AL13
IO234NB5F21	AE13
IO234PB5F21	AF13
IO235NB5F22	AN11
IO235PB5F22	AP11
IO236NB5F22	AM11
IO236PB5F22	AM12
IO237NB5F22	AJ11
IO237PB5F22	AJ12
IO238NB5F22	AH11
IO238PB5F22	AH12
IO239NB5F22	AK10
IO239PB5F22	AK11
IO240NB5F22	AE12
IO240PB5F22	AF12
IO241NB5F22	AN10
IO241PB5F22	AP10

FG1152	
AX2000 Function	**Pin Number**
IO242NB5F22	AG11
IO242PB5F22	AG12
IO243NB5F22	AL9
IO243PB5F22	AL10
IO244NB5F22	AM8
IO244PB5F22	AM9
IO245NB5F23	AH10
IO245PB5F23	AJ10
IO246NB5F23	AF10
IO246PB5F23	AF11
IO247NB5F23	AJ9
IO247PB5F23	AK9
IO248NB5F23	AN7
IO248PB5F23	AP7
IO249NB5F23	AL7
IO249PB5F23	AL8
IO250NB5F23	AE10
IO250PB5F23	AE11
IO251NB5F23	AK8
IO251PB5F23	AJ8
IO252NB5F23	AH8
IO252PB5F23	AH9
IO253NB5F23	AN6
IO253PB5F23	AP6
IO254NB5F23	AG9
IO254PB5F23	AG10
IO255NB5F23	AJ7
IO255PB5F23	AK7
IO256NB5F23	AL6
IO256PB5F23	AM6
Bank 6	
IO257NB6F24	AG6
IO257PB6F24	AH6
IO258NB6F24	AD9
IO258PB6F24	AE9

FG1152	
AX2000 Function	Pin Number
VCCIB0	C5
VCCIB0	D5
VCCIB0	L12
VCCIB0	L13
VCCIB0	L14
VCCIB0	M13
VCCIB0	M14
VCCIB0	M15
VCCIB0	M16
VCCIB0	M17
VCCIB1	A30
VCCIB1	B30
VCCIB1	C30
VCCIB1	D30
VCCIB1	L21
VCCIB1	L22
VCCIB1	L23
VCCIB1	M18
VCCIB1	M19
VCCIB1	M20
VCCIB1	M21
VCCIB1	M22
VCCIB2	E31
VCCIB2	E32
VCCIB2	E33
VCCIB2	E34
VCCIB2	M24
VCCIB2	N23
VCCIB2	N24
VCCIB2	P23
VCCIB2	P24
VCCIB2	R23
VCCIB2	T23
VCCIB2	U23
VCCIB3	AA23

FG1152	
AX2000 Function	Pin Number
VCCIB3	AA24
VCCIB3	AB23
VCCIB3	AB24
VCCIB3	AC24
VCCIB3	AK31
VCCIB3	AK32
VCCIB3	AK33
VCCIB3	AK34
VCCIB3	V23
VCCIB3	W23
VCCIB3	Y23
VCCIB4	AC18
VCCIB4	AC19
VCCIB4	AC20
VCCIB4	AC21
VCCIB4	AC22
VCCIB4	AD21
VCCIB4	AD22
VCCIB4	AD23
VCCIB4	AL30
VCCIB4	AM30
VCCIB4	AN30
VCCIB4	AP30
VCCIB5	AC13
VCCIB5	AC14
VCCIB5	AC15
VCCIB5	AC16
VCCIB5	AC17
VCCIB5	AD12
VCCIB5	AD13
VCCIB5	AD14
VCCIB5	AL5
VCCIB5	AM5
VCCIB5	AN5
VCCIB5	AP5

FG1152	
AX2000 Function	Pin Number
VCCIB6	AA11
VCCIB6	AA12
VCCIB6	AB11
VCCIB6	AB12
VCCIB6	AC11
VCCIB6	AK1
VCCIB6	AK2
VCCIB6	AK3
VCCIB6	AK4
VCCIB6	V12
VCCIB6	W12
VCCIB6	Y12
VCCIB7	E1
VCCIB7	E2
VCCIB7	E3
VCCIB7	E4
VCCIB7	M11
VCCIB7	N11
VCCIB7	N12
VCCIB7	P11
VCCIB7	P12
VCCIB7	R12
VCCIB7	T12
VCCIB7	U12
VCCPLA	J16
VCCPLB	K17
VCCPLC	J19
VCCPLD	L18
VCCPLE	AK19
VCCPLF	AE18
VCCPLG	AK16
VCCPLH	AF17
VCOMPLA	H16
VCOMPLB	L17
VCOMPLC	H19

CQ352	
AX1000 Function	Pin Number
Bank 0	
IO02NB0F0	341
IO02PB0F0	342
IO03PB0F0	343
IO04NB0F0	337
IO04PB0F0	338
IO08NB0F0	331
IO08PB0F0	332
IO09NB0F0	335
IO09PB0F0	336
IO24NB0F2	325
IO24PB0F2	326
IO25NB0F2	323
IO25PB0F2	324
IO30NB0F2/HCLKAN	319
IO30PB0F2/HCLKAP	320
IO31NB0F2/HCLKBN	313
IO31PB0F2/HCLKBP	314
Bank 1	
IO32NB1F3/HCLKCN	305
IO32PB1F3/HCLKCP	306
IO33NB1F3/HCLKDN	299
IO33PB1F3/HCLKDP	300
IO38NB1F3	295
IO38PB1F3	296
IO54NB1F5	287
IO54PB1F5	288
IO55NB1F5	289
IO55PB1F5	290
IO56NB1F5	281
IO56PB1F5	282
IO57NB1F5	283
IO57PB1F5	284
IO59NB1F5	277
IO59PB1F5	278

CQ352	
AX1000 Function	Pin Number
IO60NB1F5	275
IO60PB1F5	276
IO61NB1F5	271
IO61PB1F5	272
IO63NB1F5	269
IO63PB1F5	270
Bank 2	
IO64NB2F6	259
IO64PB2F6	260
IO67NB2F6	261
IO67PB2F6	262
IO68NB2F6	255
IO68PB2F6	256
IO69NB2F6	253
IO69PB2F6	254
IO74NB2F7	249
IO74PB2F7	250
IO75NB2F7	247
IO75PB2F7	248
IO76NB2F7	243
IO76PB2F7	244
IO77NB2F7	241
IO77PB2F7	242
IO78NB2F7	237
IO78PB2F7	238
IO79NB2F7	235
IO79PB2F7	236
IO82NB2F7	231
IO82PB2F7	232
IO83NB2F7	229
IO83PB2F7	230
IO94NB2F8	225
IO94PB2F8	226
IO95NB2F8	223
IO95PB2F8	224

CQ352	
AX1000 Function	Pin Number
Bank 3	
IO96NB3F9	217
IO96PB3F9	218
IO97NB3F9	219
IO97PB3F9	220
IO99NB3F9	213
IO99PB3F9	214
IO108NB3F10	211
IO108PB3F10	212
IO109NB3F10	207
IO109PB3F10	208
IO111NB3F10	205
IO111PB3F10	206
IO112NB3F10	199
IO112PB3F10	200
IO113NB3F10	201
IO113PB3F10	202
IO115NB3F10	195
IO115PB3F10	196
IO116NB3F10	193
IO116PB3F10	194
IO117NB3F10	189
IO117PB3F10	190
IO124NB3F11	183
IO124PB3F11	184
IO125NB3F11	187
IO125PB3F11	188
IO127NB3F11	181
IO127PB3F11	182
IO128NB3F11	179
IO128PB3F11	180
Bank 4	
IO130NB4F12	172
IO130PB4F12	173
IO131NB4F12	170

CQ352	
AX1000 Function	Pin Number
GND	21
GND	27
GND	33
GND	39
GND	45
GND	51
GND	57
GND	63
GND	69
GND	75
GND	81
GND	88
GND	89
GND	97
GND	103
GND	109
GND	115
GND	121
GND	133
GND	145
GND	151
GND	157
GND	163
GND	169
GND	176
GND	177
GND	186
GND	192
GND	198
GND	204
GND	210
GND	216
GND	222
GND	228
GND	234

CQ352	
AX1000 Function	Pin Number
GND	240
GND	246
GND	252
GND	258
GND	264
GND	265
GND	274
GND	280
GND	286
GND	292
GND	298
GND	310
GND	322
GND	330
GND	334
GND	340
GND	345
GND	352
NC	91
NC	130
NC	131
NC	174
NC	268
NC	307
NC	308
PRA	312
PRB	311
PRC	135
PRD	134
TCK	349
TDI	348
TDO	347
TMS	350
TRST	351
VCCA	3

CQ352	
AX1000 Function	Pin Number
VCCA	14
VCCA	32
VCCA	56
VCCA	74
VCCA	87
VCCA	102
VCCA	114
VCCA	150
VCCA	162
VCCA	175
VCCA	191
VCCA	209
VCCA	233
VCCA	251
VCCA	263
VCCA	279
VCCA	291
VCCA	329
VCCA	339
VCCDA	2
VCCDA	44
VCCDA	90
VCCDA	116
VCCDA	117
VCCDA	132
VCCDA	148
VCCDA	149
VCCDA	178
VCCDA	221
VCCDA	266
VCCDA	293
VCCDA	294
VCCDA	309
VCCDA	327
VCCDA	328

CG624	
AX1000 Function	Pin Number
Bank 0	
IO00NB0F0	F8
IO00PB0F0	F7
IO02NB0F0	G7
IO02PB0F0	G6
IO04NB0F0	E9
IO04PB0F0	D8
IO06NB0F0	G9
IO06PB0F0	G8
IO07PB0F0	B6
IO08NB0F0	F10
IO08PB0F0	F9
IO09PB0F0	C7
IO10NB0F0	H8
IO10PB0F0	H7
IO11NB0F0	D10
IO11PB0F0	D9
IO12NB0F1	B5
IO12PB0F1	B4
IO13NB0F1	A7
IO13PB0F1	A6
IO14NB0F1	C9
IO14PB0F1	C8
IO15PB0F1	B7
IO16NB0F1	A5
IO16PB0F1	A4
IO17NB0F1	A9
IO17PB0F1	B9
IO18NB0F1	D12
IO18PB0F1	D11
IO20NB0F1	B11
IO20PB0F1	B10
IO21NB0F1	A11
IO21PB0F1	A10
IO22NB0F2	H10
IO22PB0F2	H9

CG624	
AX1000 Function	Pin Number
IO23NB0F2	E11
IO23PB0F2	F11
IO24NB0F2	D7
IO24PB0F2	E7
IO25PB0F2	B12
IO26NB0F2	H11
IO26PB0F2	G11
IO27NB0F2	C11
IO27PB0F2	B8
IO28NB0F2	J13
IO28PB0F2	K13
IO29NB0F2	J8
IO29PB0F2	J7
IO30NB0F2/HCLKAN	G13
IO30PB0F2/HCLKAP	G12
IO31NB0F2/HCLKBN	C13
IO31PB0F2/HCLKBP	C12
Bank 1	
IO32NB1F3/HCLKCN	G15
IO32PB1F3/HCLKCP	G14
IO33NB1F3/HCLKDN	B14
IO33PB1F3/HCLKDP	B13
IO34NB1F3	G16
IO34PB1F3	H16
IO35NB1F3	C17
IO35PB1F3	B18
IO36NB1F3	H18
IO36PB1F3	H15
IO37NB1F3	H13
IO38NB1F3	E15
IO38PB1F3	F15
IO39NB1F3	D14
IO39PB1F3	C14
IO40NB1F3	D16
IO40PB1F3	D15
IO41NB1F4	F16

CG624	
AX1000 Function	Pin Number
IO42NB1F4	G21
IO42PB1F4	G20
IO43NB1F4	A16
IO43PB1F4	A15
IO44NB1F4	A20
IO44PB1F4	A19
IO45NB1F4	B17
IO45PB1F4	B16
IO46NB1F4	G17
IO46PB1F4	H17
IO47NB1F4	A17
IO48NB1F4	C19
IO48PB1F4	C18
IO49NB1F4	B20
IO49PB1F4	B19
IO50NB1F4	H20
IO50PB1F4	H19
IO51NB1F4	A22
IO51PB1F4	A21
IO52NB1F4	C21
IO52PB1F4	C20
IO53NB1F4	B22
IO53PB1F4	B21
IO54NB1F5	J18
IO54PB1F5	J19
IO55NB1F5	D18
IO55PB1F5	D17
IO56NB1F5	F20
IO56PB1F5	F19
IO58NB1F5	E17
IO58PB1F5	F17
IO60NB1F5	D20
IO60PB1F5	D19
IO62NB1F5	E18
IO62PB1F5	F18
IO63NB1F5	G19

4 – Datasheet Information

List of Changes

The following table lists critical changes that were made in the current version of the document.

Revision	Changes	Page
Revision 18 (March 2012)	Table 2-1 • Absolute Maximum Ratings was updated to correct the maximum DC core supply voltage (VCCA) from 1.6 V to 1.7 V (SAR 36786). The maximum input voltage (VI) was corrected from 3.75 V to 4.1 V (SAR 35419).	2-1
	Values for tristate leakage current IOZ, and IIH and IIL were added to Table 2-3 • Standby Current (SARs 35774, 32021).	2-2
	Figure 2-2 • VCCPLX and VCOMPLX Power Supply Connect was updated to correct the units for the resistance from "W" to Ω (SAR 36415).	2-9
	In the Introduction to the "User I/Os" section, the following sentence was added to clarify the slew rate setting (SAR 34943): The slew rate setting is effective for both rising and falling edges.	2-11
	Figure 2-3 • Use of an External Resistor for 5 V Tolerance was revised to show the VCCI and GND clamp diodes. The explanatory text above the figure was revised as well (SAR 34942).	2-13
	EQ 3 for 5 V tolerance was corrected to change Vdiode from 0.6 V to 0.7 V (SAR 36786).	2-13
	Additional information was added to the "Using the Weak Pull-Up and Pull-Down Circuits" section to clarify how the weak pull-up and pull-down resistors are physically implemented (SAR 34945).	2-17
	The description for the C_{INCLK} parameter in Table 2-18 • Input Capacitance was changed from "Input capacitance on clock pin" to "Input capacitance on HCLK and RCLK pin" (SAR 34944).	2-21
	Table 2-19 • I/O Input Rise Time and Fall Time* is new (SAR 34942).	2-21
	The minimum VIL for 1.5 V LVCMOS and PCI was corrected from –0.5 to –0.3 in Table 2-29 • DC Input and Output Levels and Table 2-33 • DC Input and Output Levels (SAR 34358).	2-38, 2-40
	Support for simulating the GCLR/ GPSET feature in the Axcelerator Family was added in Libero software v9.0 SPI1. Reference to the section explaining this in the *Antifuse Macro Library Guide* was added to the "R-Cell" section (SAR 26413).	2-58
	The enable signal in Figure 2-32 • R-Cell Delays was corrected to show it is active low rather than active high (SAR 34946).	2-59
Revision 17 (September 2011)	The versioning system for datasheets has been changed. Datasheets are assigned a revision number that increments each time the datasheet is revised. The "Axcelerator Family Device Status" table indicates the status for each device in the device family.	iii
	The "Features" section, "Programmable Interconnect Element" section, and "Security" section were revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 32865).	i, 1-1, 2-108